

CLASS II FABRICATION NOTES: (UNLESS OTHERWISE SPECIFIED)

1. BOARDS SHALL BE 100% NET LIST TESTED FOR OPENS AND SHORTS PER PROVIDED IPC-D-356 NETLIST.
2. THIS BOARD SHALL BE MANUFACTURED IN ACCORDANCE WITH IPC-6012A CLASS II SPECIFICATIONS AND MEET IPC-600 CLASS II ACCEPTABILITY STANDARDS.
3. MATERIAL:

a. FR4 PER IPC 4101B/24 /26, OR /28.

b. SIGNAL LAYERS TO BE 1 OZ. COPPER.

c. PLANE LAYERS TO BE 1 OZ. COPPER.

d. OVERALL THICKNESS TO BE 0.062" +/- 0.003"
4. LEGEND:

a. BLACK NON-CONDUCTIVE EPOXY INK BOTH SIDES.
5. SOLDERMASK:

a. APPLY LIQUID PHOTO-IMAGABLE (LPI) SOLDER MASK OVER BARE COPPER PER IPC-SM-840 CLASS H, COLOR WHITE, BOTH SIDES.
6. PLATING FINISH:

a. HOT AIR SOLDER LEVELING (HASL) SN63A SnPb SOLDER.
7. PROCESS ALLOWANCES:

a. MAXIMUM BOW AND TWIST ACROSS DIAGONAL CORNERS OF THE BOARD SHALL NOT EXCEED 0.75%.

b. HOLE DIMENSIONS APPLY AFTER PLATING.

c. ALL HOLES SHALL BE LOCATED WITHIN 0.003" DIAMETER OF TRUE POSITION.

d. LAYER TO LAYER REGISTRATION SHALL BE WITHIN 0.003".

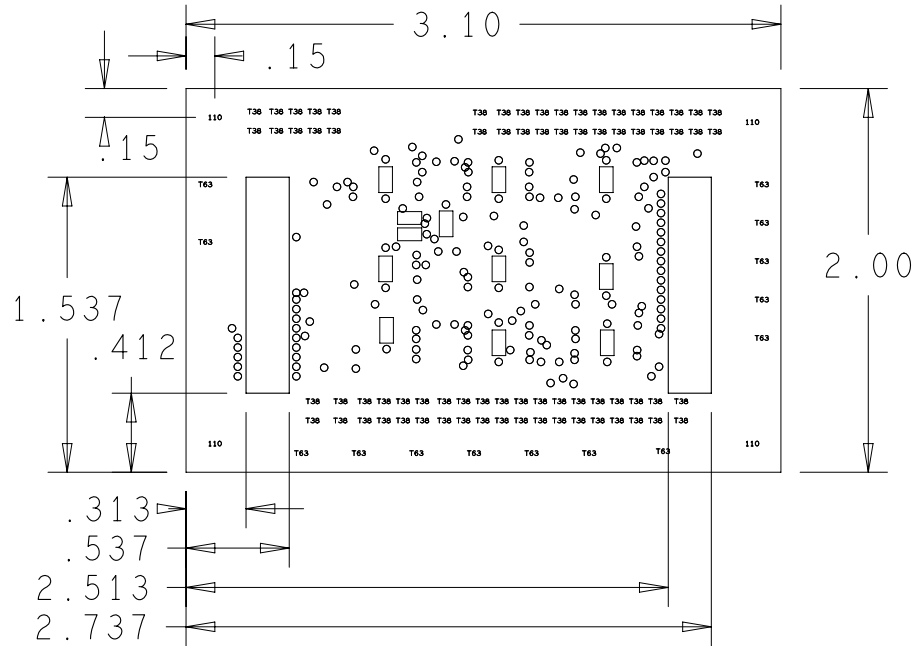
e. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/- 0.002".

f. REMOVE ALL BURRS AND BREAK SHARP EDGES 0/015" MAX.

g. CUT OUTSIDE OF 0.001" BOARD OUTLINE.

LAYER STACK-UP

- 1: TOP
- 2: GND
- 3: PWR
- 4: BOT



VISIBLE LAYERS

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
2.0	Major revision of schematic		
2.1	Swapped J1 and J2		

DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
○	10.0	PLATED	175
T36	38.0	PLATED	74
T63	63.0	PLATED	14
110	110.0	PLATED	4

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	TETHYS VEHICLE RECOVERY DAUGHTER BOARD			
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS +/- 0.02" 3 PL DECIMALS +/- 0.005" ANGLES +/- 1 Degree FRACTIONS +			MONTEREY BAY AQUARIUM RESEARCH INSTITUTE 7700 SANDHOLDT ROAD MOSS LANDING, CA			
			SIZE	REVISION	DWG NO	
			B	2-1	10020240	
	DESIGNED BY: CHAD KEY		SCALE		SHEET	
	LAYOUT BY: JOSE ROSAL		1 - 1		1 - 1	